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功率MOS FET

结构与特点

瑞萨科技功率 MOS FET 具有 D 系列 (垂直结构)和 S 系列 (水平结构)。其结构分别如图1和图2 所示。 两者在特性上稍有差别,但都拥有功率 MOS FET 在本质上的优良特性,具体内容如下:

- 无载流子的积累现象,具有优良的频率特性和开关特性。
- 无电流集中,破坏耐量大。
- 为电压控制器件,驱动功率小。



图1 D系列(垂直)的结构(N沟道)



图2 S系列(水平)的结构(N沟道)

为了解功率MOS FET的结构及特性,下面介绍一下基本的N沟道MOS FET结构和工作。

N 沟道 MOS FET 的基本结构如图 3 所示。因为控制电流的栅电极被氧化膜包围,所以该结构称为 MOS 结构。源极指的是带电粒子(这里为电子)源,漏极指的是电子的排出口。

如果对栅电极施加正电压,栅极正下方的P层就会反转形成沟道,并且漏极电流由漏极流向源极,这就是 MOS FET的工作方式 (P沟道与之相反)。

如果在漏极/源极之间施加电压,沟道内的电子就向漏极移动,并产生漏极电流。

在栅极电压为0V时,产生漏极电流的FET称为耗尽型(常开型),不产生漏极电流的FET称为增强型(常关型)。瑞萨科技功率MOS FET全部为增强型(常开型)。

将漏极电流产生时的栅极电压称为栅极截止电压V_{GS(off)}(图4)。

通常I_{DS}-V_{GS}为2次相关关系。该曲线的斜度为相互电导gm(=ΔI_{DS}/ΔV_{GS}),表示放大的尺寸。











漏极耐压由图3所示的漏极N+区域和栅电极之间的结构决定。由于漏极N+区域与栅电极的距离很近,中间只隔着很薄的栅极氧化膜,这样会在两者之间产生强电场的集中,因此不能形成较强的漏极电压。普通 MOS FET 的耐压值为20~30V。

通过扩大该漏极N+区域和栅电极的距离以缓和电场集中,可提高漏极耐压。此时,在漏极N+区域和沟道 之间形成电流通路N层。

因此,高耐压MOS FET可理解为在普通MOS FET的漏极端附加了电阻。

功率MOS FET为多个元件在内部并联的结构。

功率MOS FET的结构大致分为两种,一种称为D系列(垂直结构),另一种称为S系列(水平结构)其结构如图1和图2所示。下面对各系列的结构及特点进行更详细的说明。

D系列(垂直结构)

在D系列中漏极N+区域位于硅电路板的下方。栅电极覆盖在沟道之间的整个N層上,以缓和栅极下方的电场集中。电子由源极水平穿过沟道到达N层。此时,栅电极的正电压在N层表面形成了N+积累层,电子在通过N+积累层后,垂直穿过整个N层到达漏极。因此,将D系列称为垂直结构,并且外壳为漏极。

由于保持漏极电压的部分(N层)位于硅中,所以,D系列的单个体积比S系列要小,并且,与相同电压、相同芯片尺寸的S系列相比,D系列的通态电阻更小。

静电电容具有如图5所示的结电容和MOS电容。

因为栅极/漏极之间的电容C_{GD}比较大,因此不能忽视C_{GD}对源极接地的输入电容Ciss、输出电容Coss 及反馈电容Crss的影响。 Ciss=C_{GS}+CGD Coss=C_{DS}+C_{GD} Crss=C_{GD}





图5 D系列 (垂直型)的结构 (N沟道)

栅电极采用了在CMOS LSI中具有实际功效的多晶硅。多晶硅的电阻比铝或钼等金属材料高100倍左右,但通过改进多晶硅栅与金属电极的连接后,降低了栅极电阻。在垂直结构中,因为反馈电容 Cgd 较大,并且漏极电压的依存性较强,所以不能单纯由栅极电阻的时间常数来决定输入电容。这样,关于开关时间的工作分析变得更为复杂。详细内容记载于《功率MOS FET 使用时的注意事项》。

• S系列 (水平结构)

在S系列中漏极N+区域位于硅表面。在漏极N+区域与沟道之间设置了N层,可使电场强度平均。而且,使源电极扩展到了N层上面,可作为场板来防止栅极附近的电场集中。电子由源极水平穿过沟道及N层到达漏极。因此,将S系列称为水平结构。为了使衬底保持一定的电位,将衬底连接到了源电极,外壳为源极。

反馈电容Crss对应图6中的Cgd。由于源极场板扩展到了N层上,因此可通过场板与N层的电容Cds来 屏蔽Cgd,使得反馈电容Crss的值非常小。

从芯片及封装两方面来看, S系列的结构适用于输入端与输出端分离的高频产品。



图6 S系列 (水平型)的结构 (N沟道)



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